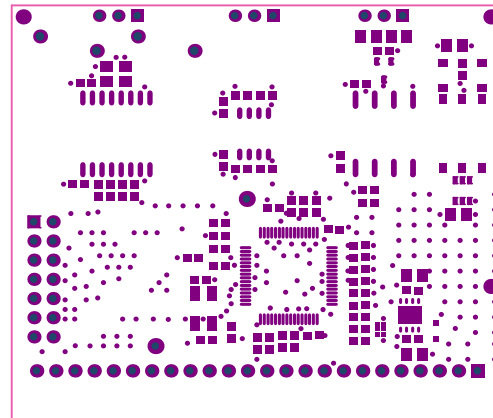
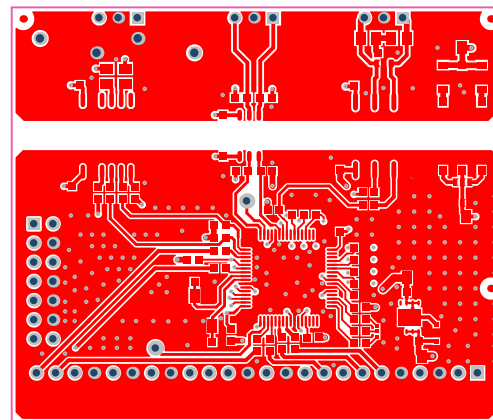


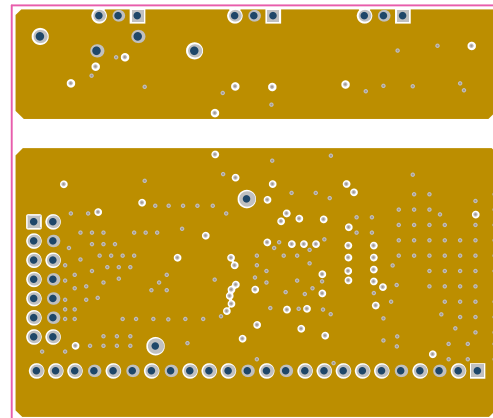
| | | | |
|----------------------------------|-----------------------|-------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | TID #: TIDA-01281 | | |
| PLOT NAME = Top Overlay | GENERATED : 12/8/2016 | 11:52:54 AM | TEXAS INSTRUMENTS |



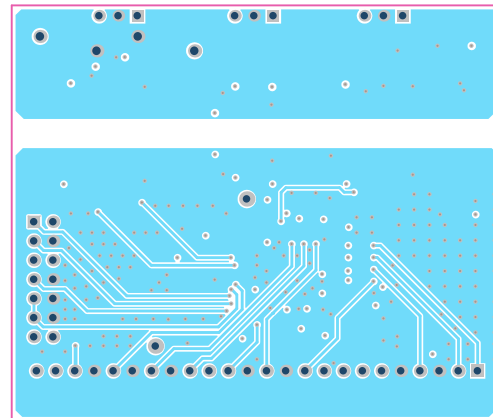
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | TID #: TIDA-01281 | | |
| PLOT NAME = Top Solder Mask | GENERATED : 12/8/2016 11:52:55 AM | TEXAS INSTRUMENTS | |



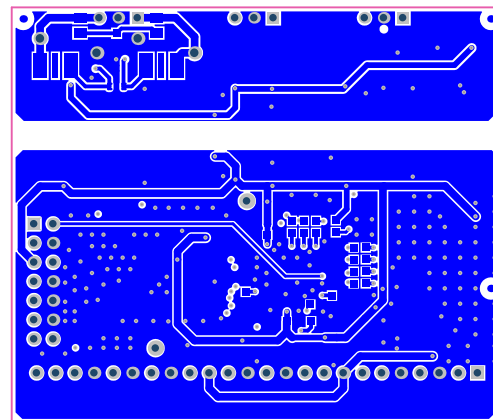
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | TID #: TIDA-01281 | | |
| PLOT NAME = Top Layer | GENERATED : 12/8/2016 11:52:56 AM | TEXAS INSTRUMENTS | |



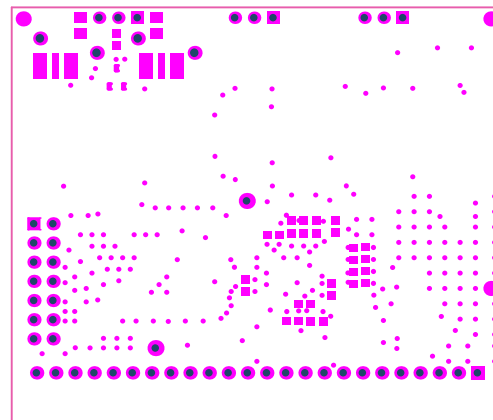
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = GND | TID #: TIDA-01281 | | |
| PLOT NAME = Signal Layer 1 | GENERATED : 12/8/2016 11:52:57 AM | TEXAS INSTRUMENTS | |



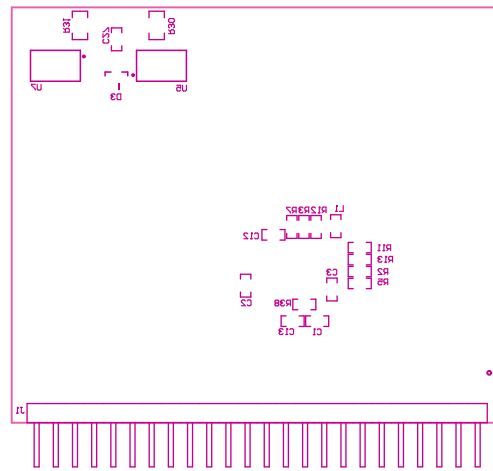
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = SIGNAL | TID #: TIDA-01281 | | |
| PLOT NAME = Signal Layer 2 | GENERATED : 12/8/2016 11:52:58 AM | TEXAS INSTRUMENTS | |



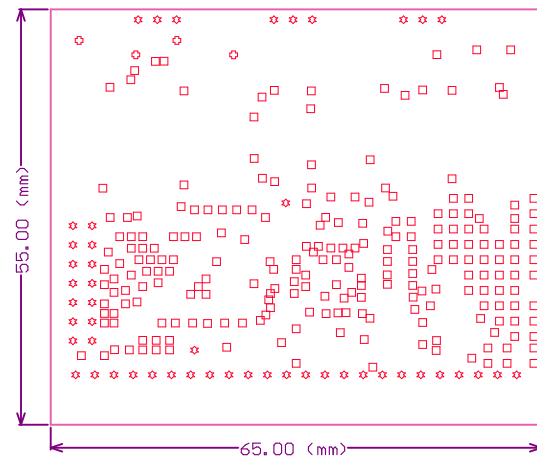
| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | TID #: TIDA-01281 | | |
| PLOT NAME = Bottom Layer | GENERATED : 12/8/2016 11:52:59 AM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | TID #: TIDA-01281 | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 12/8/2016 11:53:00 AM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | TID #: TIDA-01281 | | |
| PLOT NAME = Bottom Overlay | GENERATED : 12/8/2016 11:53:01 AM | TEXAS INSTRUMENTS | |



| Symbol | Hit Count | Finished Hole Size | Plated | Hole Type |
|--------|-----------|--------------------|--------|-----------|
| ⊙ | 4 | 45.28mil (1.150mm) | PTH | Round |
| ☆ | 49 | 40.00mil (1.016mm) | PTH | Round |
| □ | 231 | 12.00mil (0.305mm) | PTH | Round |
| | 284 Total | | | |

DRILL TABLE
 FOR 12MIL DRILL +0/-12MIL
 FOR PTH +3/-3MIL
 This is not impedance controlled board.



| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-01281 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | TID #: TIDA-01281 | | |
| PLOT NAME = Drill Drawing | GENERATED : 12/8/2016 11:53:02 AM | TEXAS INSTRUMENTS | |

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